



THERMINIC

2020

[[26th INTERNATIONAL WORKSHOP
Thermal Investigations of ICs and Systems]]

Berlin, September 24, 2020

SPONSORING ORDER FORM

We would like to confirm our booking of:

Premium sponsorship (Cost: EUR 3,000)

- Four complimentary registrations
- Your logo below 4 general mailings to our mailing list of 1000+ contacts from the THERMINIC community
- Your logo on conference website and on the virtual conference platform
- Opportunity to contact all participants through conference platform
- Your logo on the webpage of the all-day livestream on September 24
- Slides and trailers with the sponsor logos during the all-day livestream
- Premium company profile on conference website
- Two company leaflets or brochures in virtual conference package
- Mentioning in welcome and closing address of conference chair
- Optional virtual exhibition booth
- Optional vendor talk



Sponsorship (Cost: EUR 2,000)

- Two complimentary registrations
- Your logo below 4 general mailings to our mailing list of 1000+ contacts from the THERMINIC community
- Short company profile on conference website
- Your logo on conference website and on the virtual conference platform
- Opportunity to contact all participants through the conference platform
- Your logo on the webpage of the all-day livestream on September 24
- Slides and trailers with the sponsor logos during the all-day livestream
- Mentioning in welcome and closing address of conference chair
- Company leaflet or brochure in virtual conference package
- Optional vendor talk



Sponsor/Exhibitor

Company/Organization:

Contact: Function:

Address:

Phone: Email:

Invoice Address (if different from above):

Please stamp, sign and return to:

THERMINIC 2020 Conference Office

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